AMENDMENTS

In the Specification:

Amend the Title to read <u>METHOD OF MANUFACTURING</u> SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF.

Page 1, after the title, insert the following:

Reference to the Related Application:

	This applicati	on is a div	rision of Se	rial No. 10)/215,188, t	filed August 9,	2002, now l	U.S
Patent l	No							

2